

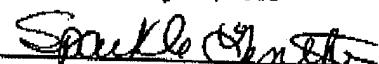
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent
appln. of: Blackshear et al.
Serial No.: 10/056,256
Filed: January 24, 2002
For: VERTICALLY STACKED MEMORY
CHIPS IN FBGA PACKAGES
Examiner: Thai, Luan C.
Grp. Art Unit: 2827
Atty. Dkt.: FIS9-2000-0273US1

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In response to the Office Action mailed December 4, 2002, please amend the above-
identified patent application as follows: